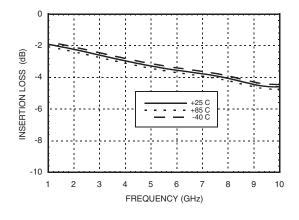


RoHS V

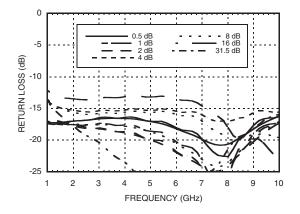
0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, 2.2 - 8.0 GHz

Insertion Loss



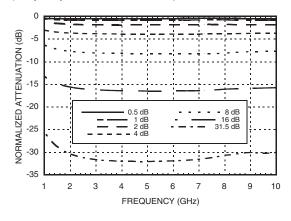
Return Loss RF1, RF2

(Only Major States are Shown)

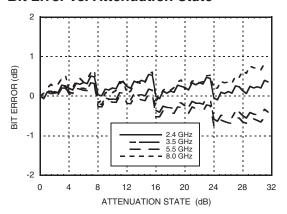


Normalized Attenuation

(Only Major States are Shown)

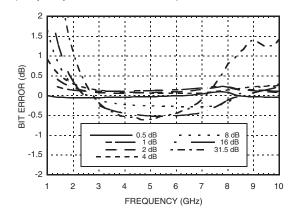


Bit Error vs. Attenuation State



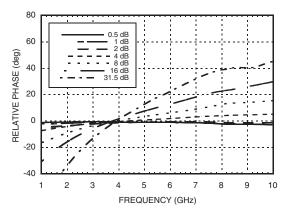
Bit Error vs. Frequency

(Only Major States are Shown)



Relative Phase vs. Frequency

(Only Major States are Shown)

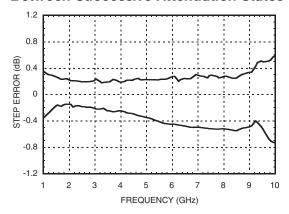






0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, 2.2 - 8.0 GHz

Worst Case Step Error Between Successive Attenuation States



Truth Table

Control Voltage Input				Attenua-		
V1 16 dB	V2 8 dB	V3 4 dB	V4 2 dB	V5 1 dB	V6 0.5 dB	tion State RF1 - RF2
High	High	High	High	High	High	Reference I.L.
High	High	High	High	High	Low	0.5 dB
High	High	High	High	Low	High	1 dB
High	High	High	Low	High	High	2 dB
High	High	Low	High	High	High	4 dB
High	Low	High	High	High	High	8 dB
Low	High	High	High	High	High	16 dB
Low	Low	Low	Low	Low	Low	31.5 dB

Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.

Bias Voltage & Current

Vdd Range = 3.0 to +5.0 Vdc			
Vdd (VDC)	ldd (Typ.) (μΑ)		
+3.0	10		
+5.0	30		

Control Voltage

State	Bias Condition	
Low	0 to 0.2V @ 10 uA Typ.	
High	Vdd ± 0.2V @ 5 uA Typ.	
Note: $Vdd = +3V to +5V$		



RoHS (E)

0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, 2.2 - 8.0 GHz

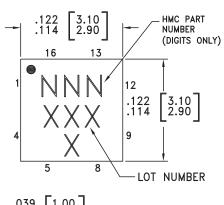
Absolute Maximum Ratings

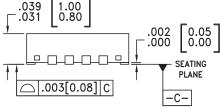
Control Voltage (V1 to V6)	Vdd +0.5 Vdc	
Bias Voltage (Vdd)	+7.0 Vdc	
Staorage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
RF Input Power (2.4 - 8.0 GHz)	+30 dBm	
ESD Sensitivity (HBM)	Class 1A	



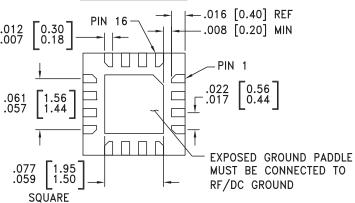
ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing





BOTTOM VIEW



NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
 PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC425LP3	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	425 XXXX
HMC425LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	425 XXXX

- [1] Max peak reflow temperature of 235 $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX

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HMC425LP3 / 425LP3E

v03.0409



0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, 2.2 - 8.0 GHz

Pin Descriptions

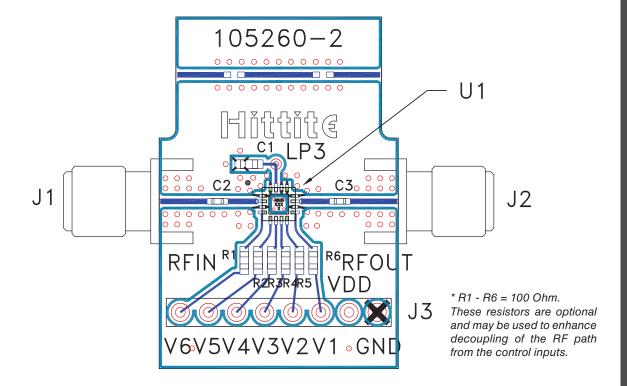
Pin Number	Function	Description	Interface Schematic
1, 3, 10, 12	GND	Package bottom has an exposed metal paddle that must also be connected to RF ground.	○ GND =
2, 11	RFIN, RFOUT	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required.	
4, 5, 6, 7, 8, 9	V1 - V6	See truth table and control voltage table.	→ Vdd → 500 → → — — — — — — — — — — — — — — — — — —
13, 14, 16	N/C	This pin should be connected to PCB RF ground to maximize performance.	
15	Vdd	Supply Voltage.	





0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, 2.2 - 8.0 GHz

Evaluation PCB



List of Materials for Evaluation PCB 105408 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	8 Pin DC Connector
C1	0.01 μF Capacitor, 0603 Pkg.
C2, C3	100 pF Capacitor, 0402 Pkg.
R1 - R6	100 Ohm Resistor, 0603 Pkg.
U1	HMC425LP3 / HMC425LP3E Digital Attenuator
PCB [2]	105260 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

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Analog Devices Inc.:

HMC425LP3ETR HMC425LP3E HMC425LP3 HMC425LP3TR